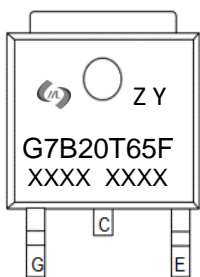


Features

- IGBT CHIP(Trench+Field Stop technology)
- Low Vcesat(typ) 1.56V@IC=20A
- Maximum junction temperature 175°C
- Low gate charge Qg
- RoHS compliant

Application

- DC-AC inverters
- Motion/servo control
- UPS systems

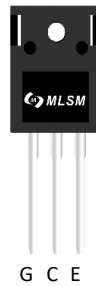


Marking and pin assignment

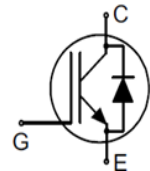
G7B20T65F : Device code
 XXXXXXXX : Code

Product Summary

V _{CE}	I _C (T _J =100°C)	V _{CE(sat)}
650V	20A	1.56V


 TO-247
 top view

 TO-263-2L
 top view

 TO-220F
 top view


Schematic diagram



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (TC=25 °C unless otherwise noted)						
Symbol	Parameter	Rating	Unit			
Common Ratings (TC=25 °C Unless Otherwise Noted)						
IGBT, Inverter						
V _{CES}	Collector Emitter Voltage	T _J =25°C	650	V		
V _{GES}	Gate Emitter Voltage		±30	V		
I _C	DC Collector Current	T _C =25°C	40	A		
		T _C =100°C	20	A		
I _{CRM}	Pulsed Collector Current, Limited by T _{vjmax}	tp=1ms	80	A		
P _D	Power Dissipation	T _C =25°C	311	W		
		T _C =100°C	155	W		
Diode, Inverter						
V _{RRM}	Repetitive Reverse Voltage	T _J =25°C	650	V		
I _F	Forward current,DC	T _C =25°C	40	A		
		T _J =100°C	20	A		
T _J , T _{stg}	Operating Junction and Storage Temperature Range		-55 to +175	°C		
Ordering Information (Example)						
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MGB20T65F7	TO-263	G7B20T65F	800	800	4,000	13"reel
MGA20T65F7	TO-247	G7A20T65F	30	270	2,160	Tube
MGYF20T65F7	TO-220F	G7D20T65F	50	1,000	5,000	Tube

IGBT, Inverter

Electrical Characteristics (TC=25°C unless otherwise noted)							
Symbol	Parameter	Condition	Min	Typ	Max	Unit	
Static Electrical Characteristics @ TC= 25°C (unless otherwise stated)							
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=0.25mA, T_J=25^\circ C$	5.0	5.8	6.5	V	
$V_{CE(sat)}$	Collector - Emitter Saturation Voltage	$I_C=20A, V_{GE}=15V, T_J=25^\circ C$	--	1.56	2.1	V	
		$I_C=20A, V_{GE}=15V, T_J=150^\circ C$	--	1.92	--	V	
I_{CES}	Collector Leakage Current	$V_{CE}=650V, V_{GE}=0V, T_J=25^\circ C$	--	--	500	nA	
I_{GES}	Gate Leakage Current	$V_{CE}=0V, V_{GE}=20V, T_J=25^\circ C$	--	--	500	nA	
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)							
Q_g	Gate Charge	$V_{CE}=480V, I_C=20A, V_{GE}=0 \text{ to } 15V$	--	57.75	--	nC	
Q_{ge}	Gate to Emitter Charge		--	17.52	--	nC	
Q_{gc}	Gate to Collector Charge		--	22.65	--	nC	
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	--	1681	--	pF	
C_{oes}	Output Capacitance		--	56	--	pF	
C_{res}	Reverse Transfer Capacitance		--	5	--	pF	
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=400V, I_C=20A$ $R_{G(on)}=10\Omega, R_{G(off)}=10\Omega$ $V_{GE}=15V,$ Inductive Load	$T_J=25^\circ C$	--	32.2	--	ns
			$T_J=150^\circ C$	--	33.5	--	ns
t_r	Turn-on Rise Time		$T_J=25^\circ C$	--	35.2	--	ns
			$T_J=150^\circ C$	--	39.6	--	ns
$t_{d(off)}$	Turn-Off Delay Time		$T_J=25^\circ C$	--	108.1	--	ns
			$T_J=150^\circ C$	--	129.6	--	ns
t_f	Turn-Off Fall Time		$T_J=25^\circ C$	--	15.3	--	ns
			$T_J=150^\circ C$	--	21.6	--	ns
E_{on}	Turn on Energy		$T_J=25^\circ C$	--	0.11	--	mJ
			$T_J=150^\circ C$	--	0.21	--	mJ
E_{off}	Turn off Energy		$T_J=25^\circ C$	--	0.56	--	mJ
			$T_J=150^\circ C$	--	0.68	--	mJ

Diode, Inverter

Absolute Maximum Ratings (TC=25°C unless otherwise noted)							
Symbol	Parameter	Min	Typ	Max	Unit		
Common Ratings (TC=25°C Unless Otherwise Noted)							
V_F	Forward Voltage	$I_F=20A, V_{GE}=0V,$	$T_J=25^\circ C$	--	1.77	2.2	V
			$T_J=150^\circ C$	--	1.63	--	V
t_{rr}	Reverse Recovery Time	$I_F=20A, V_R=400V$ $dI_F/dt=200A/\mu s$	$T_J=25^\circ C$	--	128	--	ns
			$T_J=150^\circ C$	--	220	--	ns
I_{rm}	Peak reverse recovery current		$T_J=25^\circ C$	--	6	--	A
			$T_J=150^\circ C$	--	10	--	A
Q_{rr}	Repetitive peak forward current		$T_J=25^\circ C$	--	411	--	nC
			$T_J=150^\circ C$	--	1216	--	nC

Typical Operating Characteristics

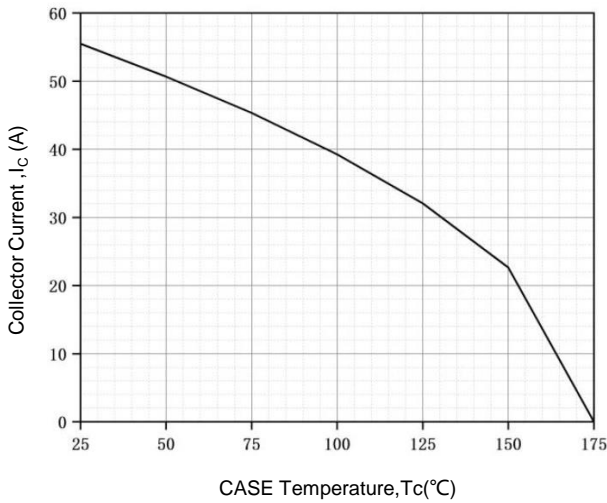


Figure 1. Collector current as a function of case temperature

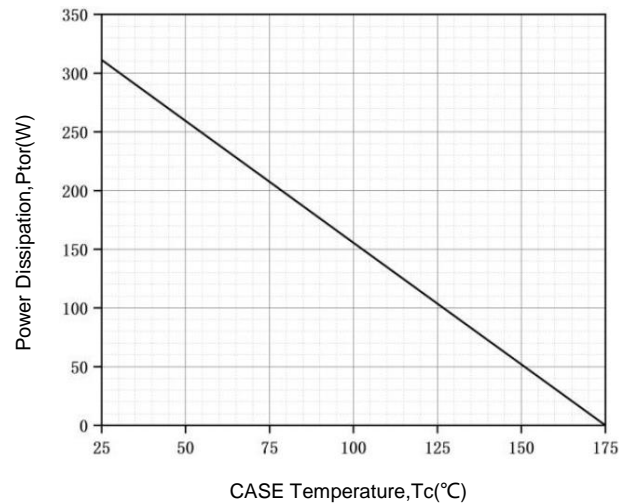


Figure 2. Power dissipation as a function of case temperature

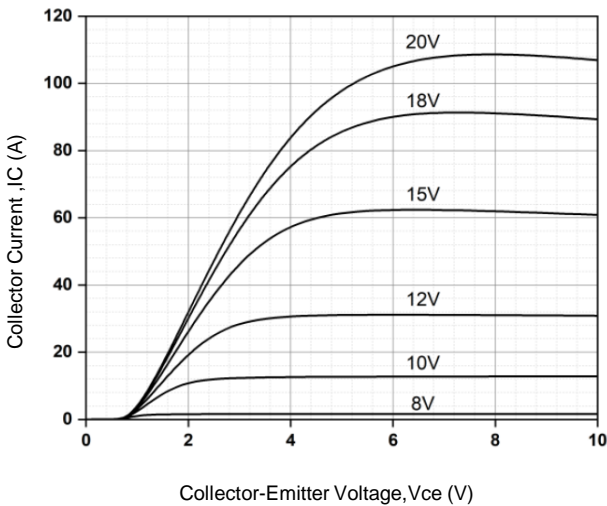


Figure 3. Typical output characteristic (Tj=25°C)

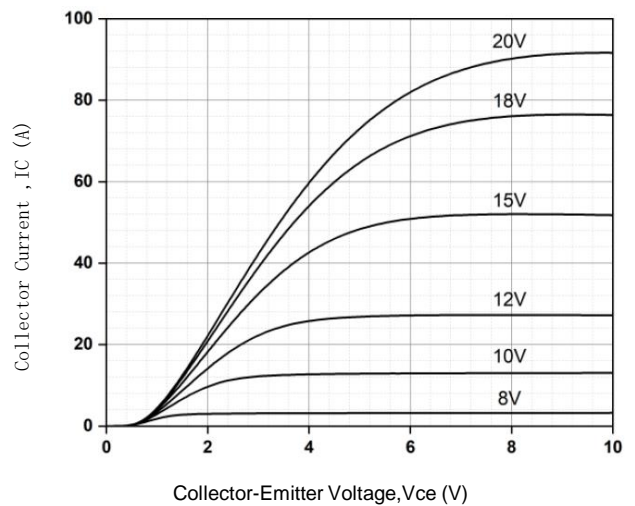


Figure 4. Typical output characteristic (Tj=150°C)

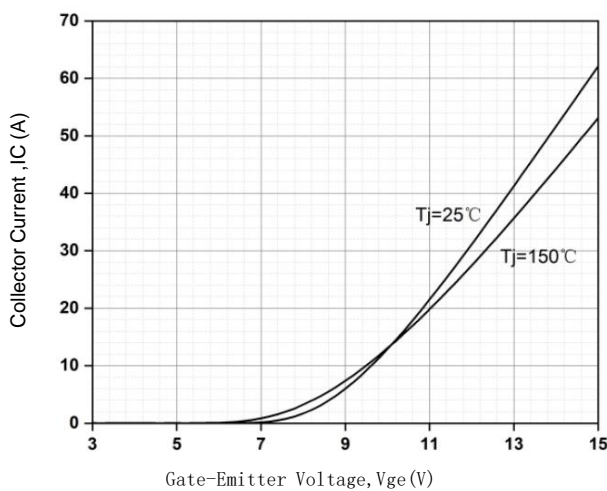


Figure 5. Typical transfer characteristic (Vce=10V)

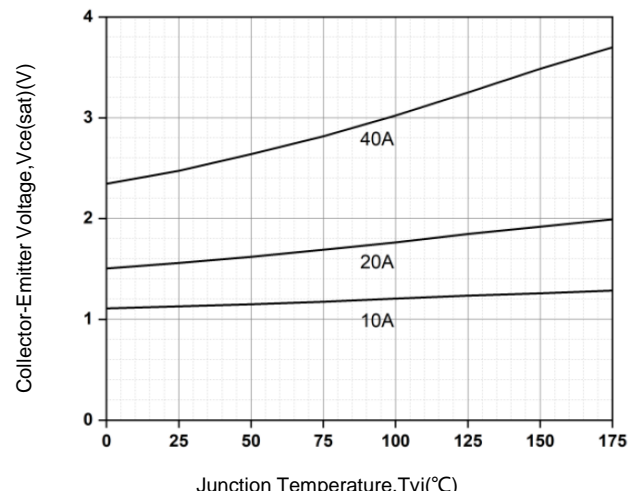


Figure 6. Typical collector-emitter saturation voltage as a function of junction temperature

Typical Operating Characteristics

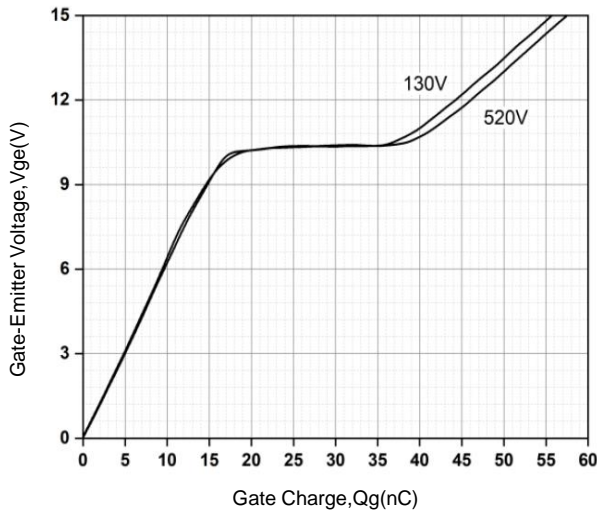


Figure 7. Typical gate charge

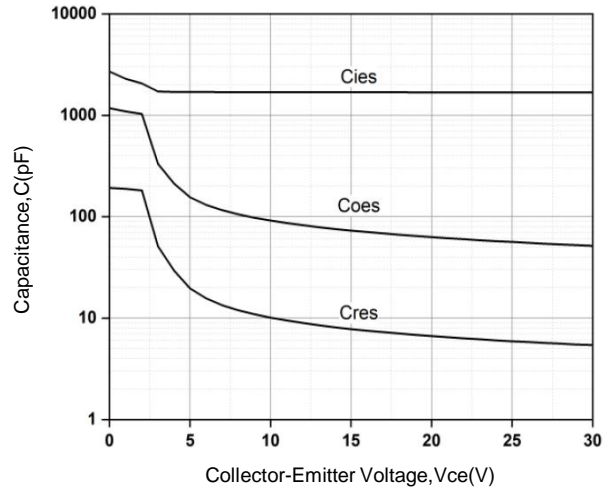


Figure 8. Typical capacitance as a function of collector-emitter voltage (f=1MHz)

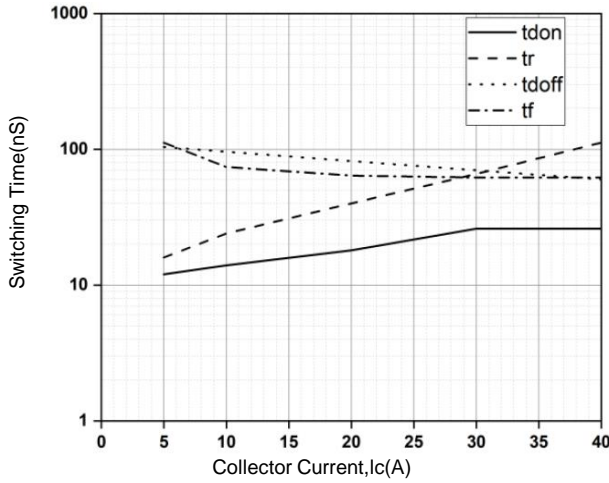


Figure 9. Typical switching times as a function of

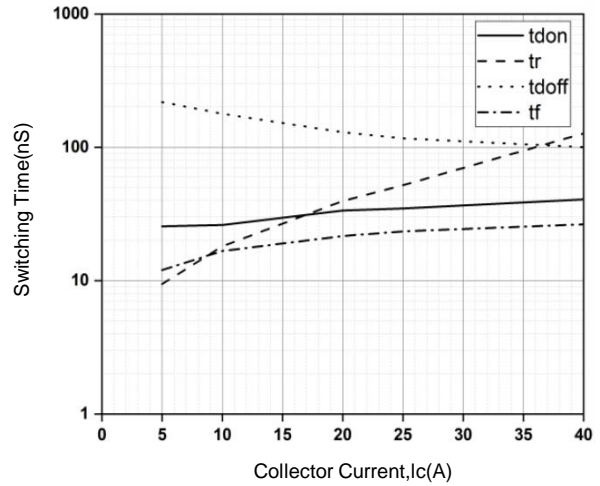


Figure 10. Typical switching times as a function of

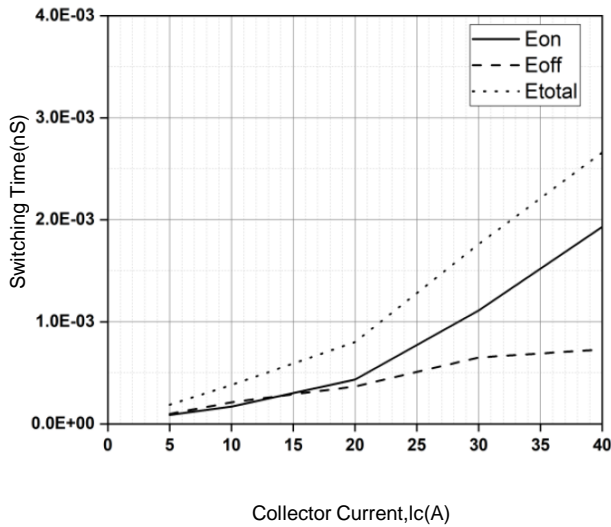


Figure 11. Typical switching energy losses as a function

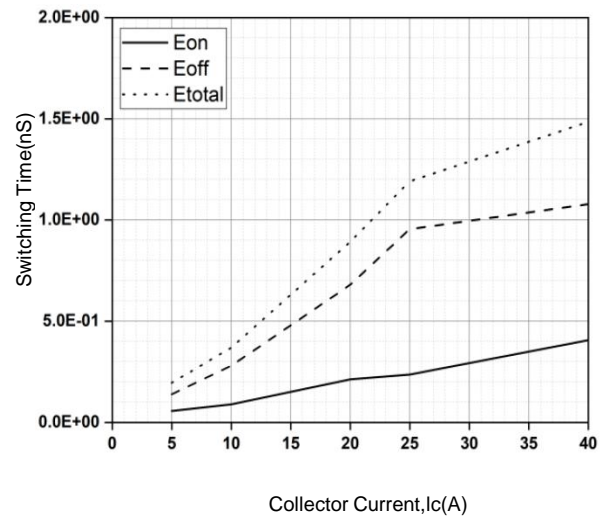


Figure 12. Typical switching energy losses as a function

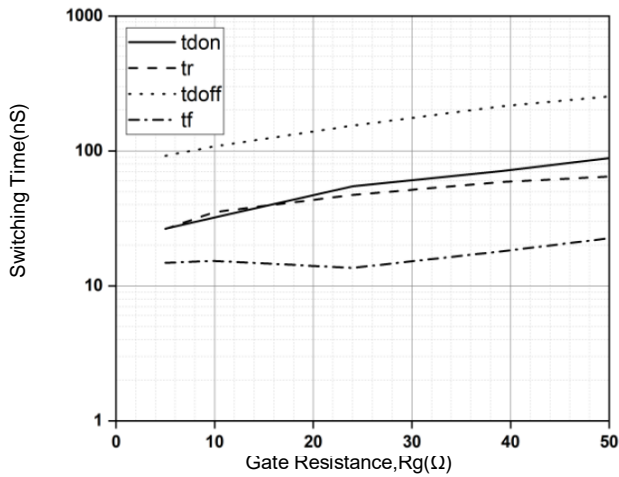


Figure 13. Typical switching times as a function of

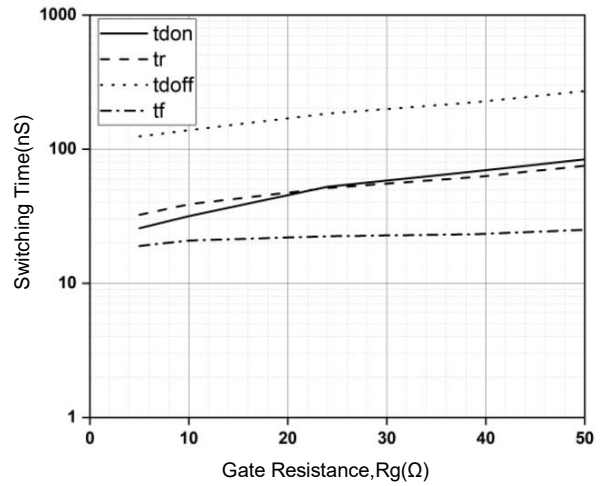


Figure 14. Typical switching times as a function of

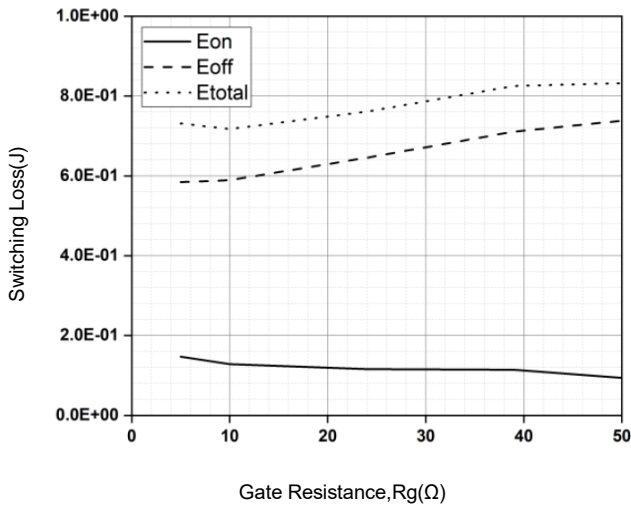


Figure 15. Typical switching energy losses as a function of

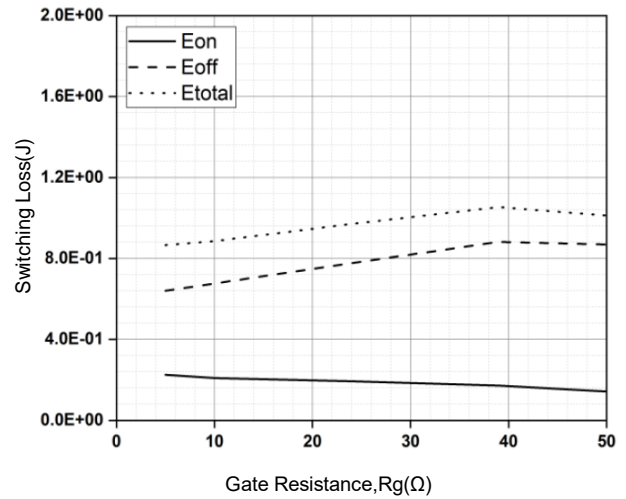


Figure 16. Typical switching energy losses as a function of

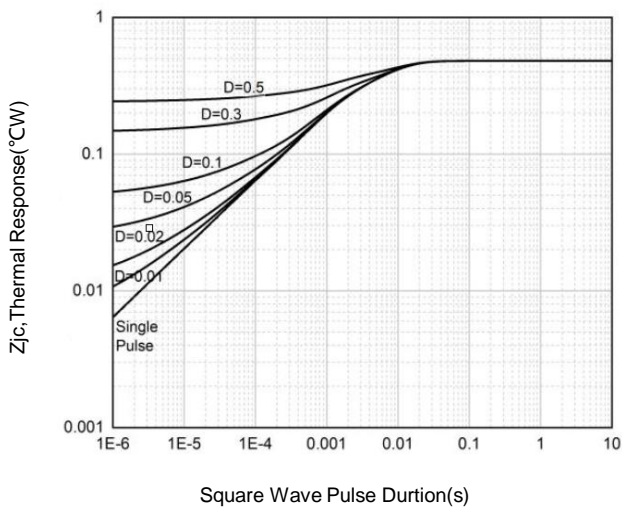


Figure 17. IGBT transient thermal impedance($D=tp/T$)

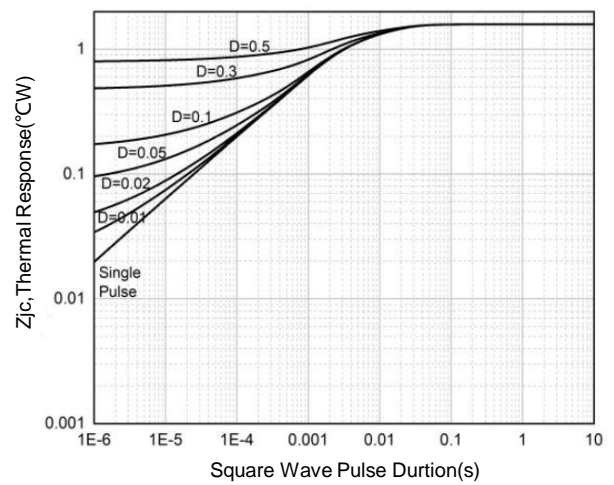


Figure 18. Diode transient thermal impedance as a function of pulse width($D=tp/T$)

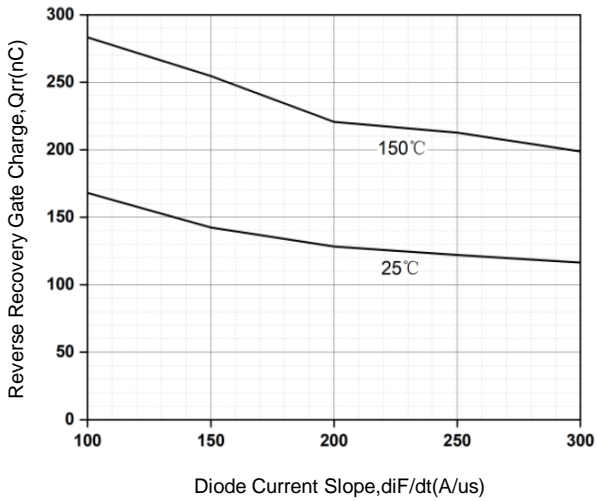


Figure 19. Typical reverse recovery charge as a function of diode current slope ($V_{CC}=400V$, $I_F=6A$)

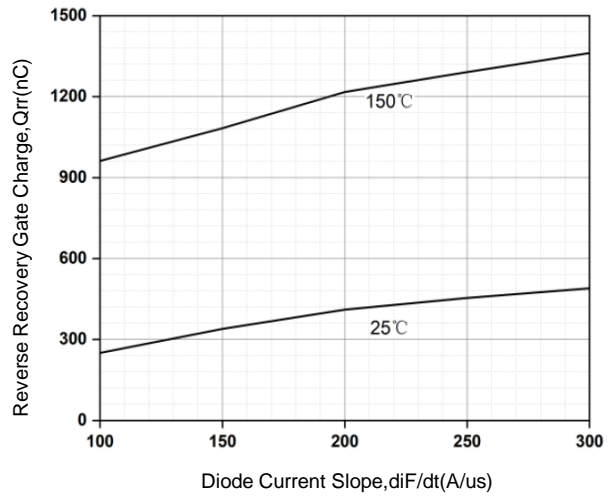


Figure 20. Typical reverse recovery time as a function of diode current slope ($V_{CC}=400V$, $I_F=6A$)

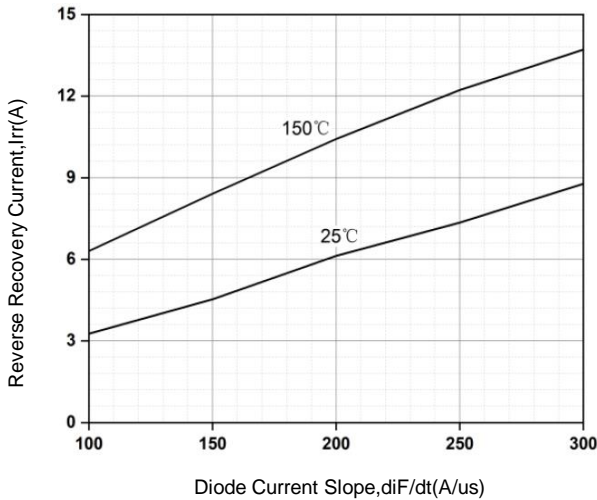


Figure 21. Typical reverse recovery current as a function of diode current slope ($V_{CC}=400V$, $I_F=6A$)

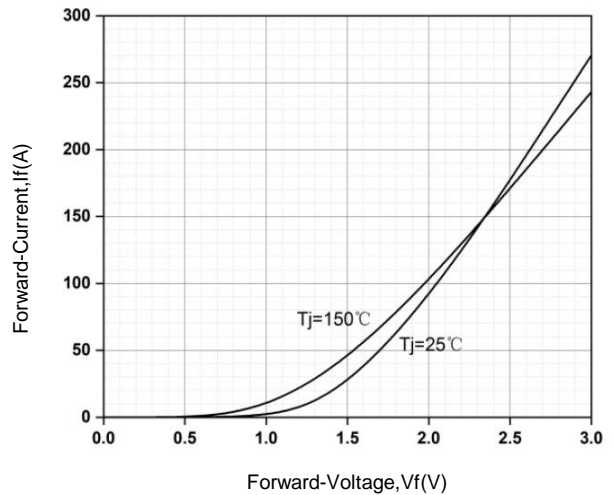


Figure 22. Typical diode forward current as a function of forward voltage

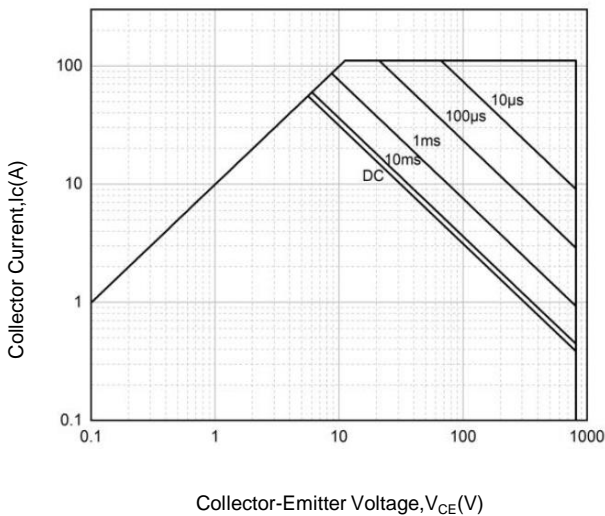
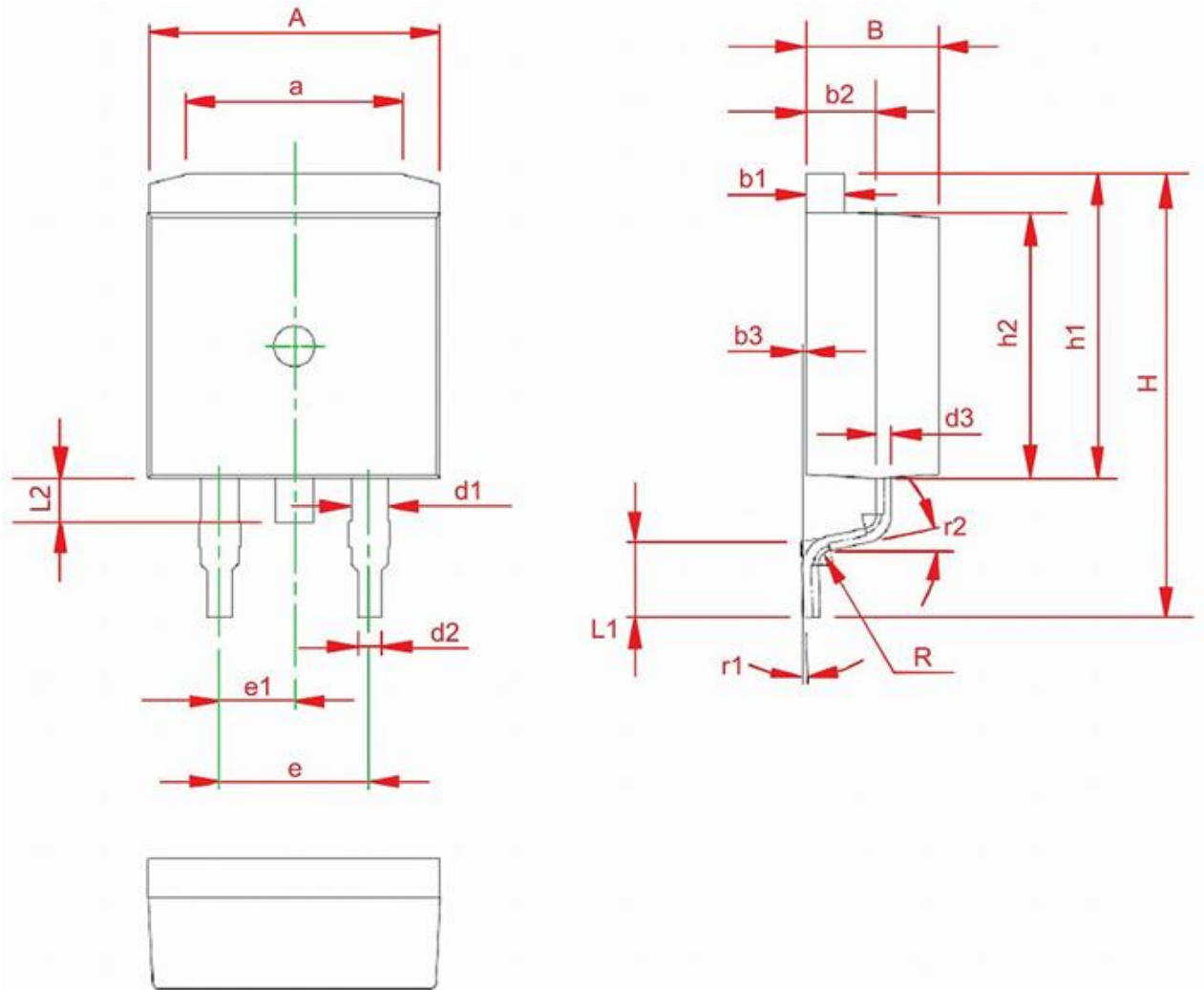
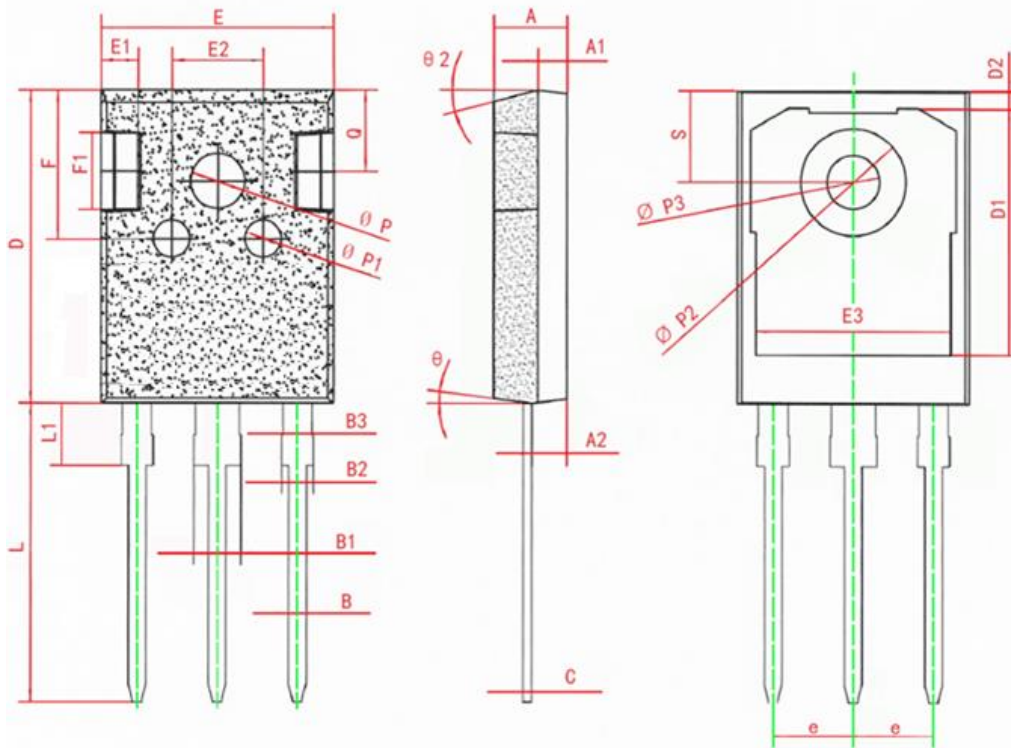


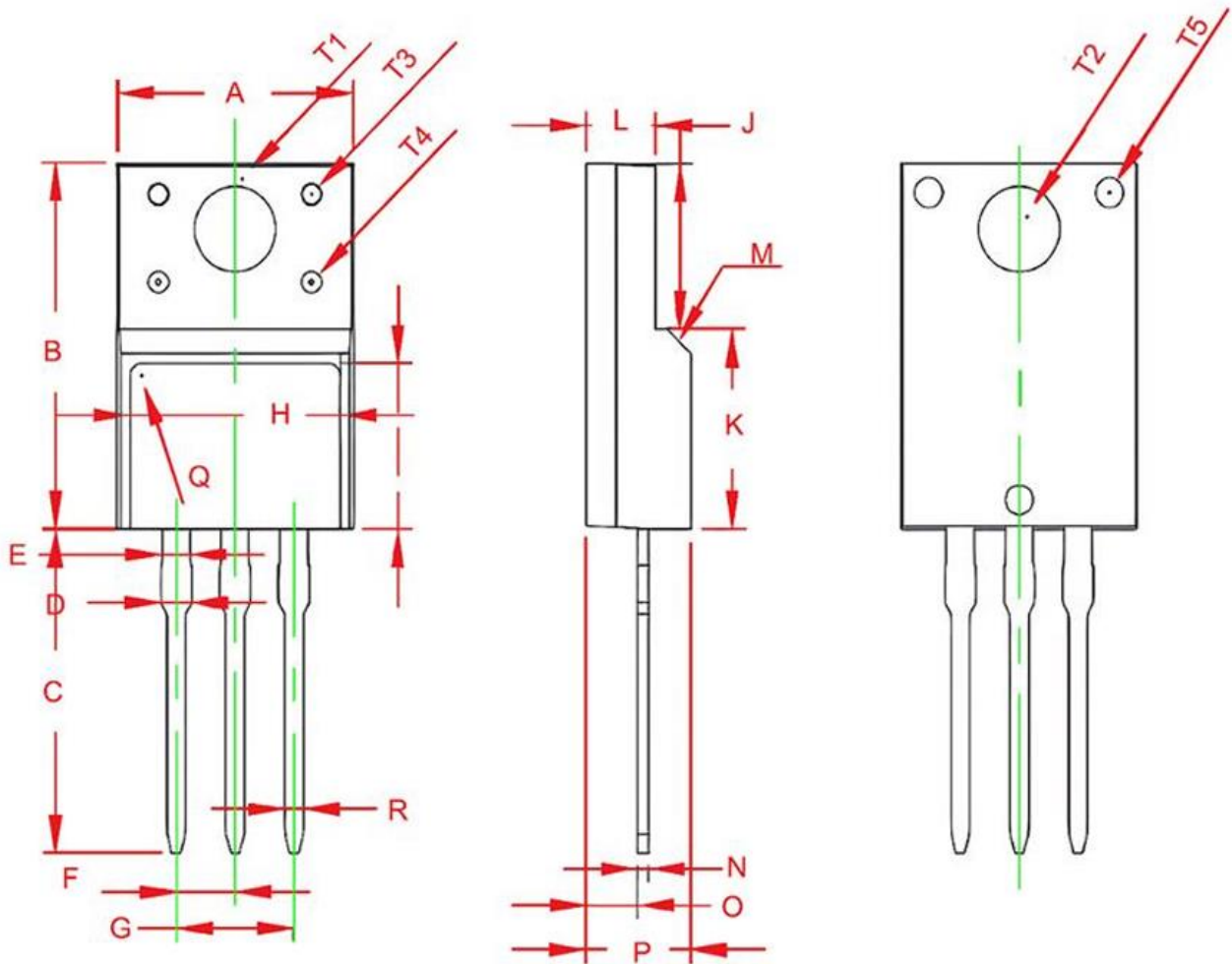
Figure 23. Safe operating area

TO-263 Package information


Symbol	Dimensions in Millimeters(mm)		Symbol	Dimensions in Millimeters(mm)	
	Min	Max		Min	Max
A	9.700	10.300	e1	2.54TYP	
a	7.000	7.800	H	14.800	15.600
B	4.300	4.700	h1	10.200	10.700
b1	1.250	1.350	h2	8.900	9.400
b2	2.200	2.600	L1	2.400	2.900
b3	0.000	0.200	L2	1.300	1.800
d1	1.200	1.400	R	0.5TYP	
d2	0.700	0.900	r1	0°	8°
d3	0.400	0.600	r2	12°TYP	
e	5.08TYP				

TO-247 Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	4.900	5.100	0.192	0.200
A1	1.900	2.100	0.074	0.082
A2	2.300	2.500	0.090	0.098
B	1.140	1.240	0.044	0.048
B1	3.050	3.250	0.120	0.127
B2	2.000	2.200	0.078	0.086
B3	1.900	2.100	0.074	0.082
C	0.550	0.650	0.021	0.025
D	20.800	21.200	0.818	0.834
D1	16.350	16.750	0.643	0.659
D2	1.020	1.320	0.040	0.051
E	15.600	16.000	0.614	0.629
E1	2.400	2.600	0.094	0.102
E2	6.100	6.300	0.240	0.248
E3	13.060	13.460	0.514	0.529
F	9.800	10.200	0.385	0.401
F1	4.800	5.400	0.188	0.212
F2	7.900	8.100	0.311	0.318
e	5.436BSC		0.214BSC	
L	19.720	20.120	0.776	0.792
L1	3.900	4.300	0.153	0.169
Phi P	3.550	3.950	0.139	0.155
Phi P1	2.400	2.600	0.094	0.102
Phi P2	7.090	7.290	0.279	0.287
Phi P3	3.500	3.700	0.137	0.145
S	6.050	6.250	0.238	0.246
Q	5.400	5.600	0.212	0.220
theta	5°	9°	5°	9°
theta1	5°	9°	5°	9°
theta2	13°	17°	13°	17°

TO-220F Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	9.960	10.360	0.392	0.407
B	15.670	16.070	0.616	0.632
C	13.140	13.540	0.517	0.533
D	1.200	1.400	0.047	0.055
E	1.200TYP		0.047TYP	
F	2.540TYP		0.100TYP	
G	5.080TYP		0.200TYP	
H	7.600	8.000	0.299	0.314
I	7.100	7.500	0.279	0.295
J	6.480	6.880	0.255	0.270
K	8.990	9.390	0.353	0.369
L	2.340	2.740	0.092	0.107
M	45°TYP		45°TYP	
N	0.490	0.520	0.019	0.020
O	2.150	2.550	0.084	0.100
P	4.500	4.900	0.177	0.192
Q	0.500TYP		0.019TYP	
S	4.5°TYP		4.5°TYP	
T1	3.450TYP		0.135TYP	
T2	3.180TYP		0.125TYP	
T3	1.500TYP		0.059TYP	
T4	1.200TYP		0.047TYP	
T5	1.500TYP		0.059TYP	
R	0.770	0.830	0.030	0.032